

**Gate resistor installed
Dual N-channel MOSFET**

**KFC4B21330L
Data Sheet**

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1. GENERAL DESCRIPTION

Gate resistor installed Dual N-channel MOSFET
For lithium-ion secondary battery protection circuits

2. FEATURES

- Source-source ON resistance: $R_{SS(on)}$ typ. = 95 mΩ ($V_{GS} = 4.5$ V)
- CSP (Chip Size Package)
- RoHS compliant (EU RoHS / MSL: Level 1 compliant)

3. MARKING SYMBOL: 2E

4. PACKAGING

Embossed type (Thermo-compression sealing): 20,000 pcs / reel (standard)

5. ABSOLUTE MAXIMUM RATINGS $T_a = 25$ °C

Parameter	Symbol	Rating	Unit
Source-source Voltage	V _{SS}	12	V
Gate-source Voltage	V _{GSS}	± 8	V
Source Current (DC)	I _{S1} ^{*1}	1.5	A
	I _{S2} ^{*2}	2.5	A
Source Current (Pulsed)	I _{Sp} ^{*3}	15	A
Total Power Dissipation	P _{D1} ^{*1}	0.34	W
	P _{D2} ^{*2}	0.9	W
Channel Temperature	T _{ch}	150	°C
Storage Temperature Range	T _{stg}	-55 to +150	°C

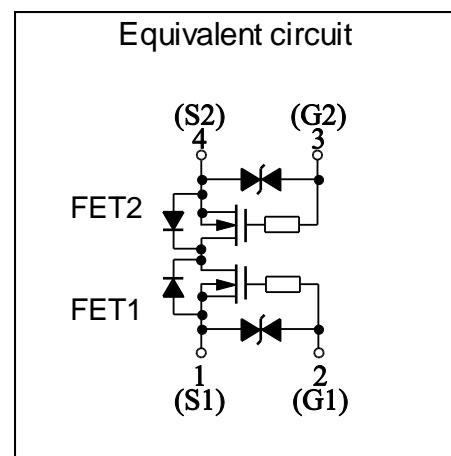
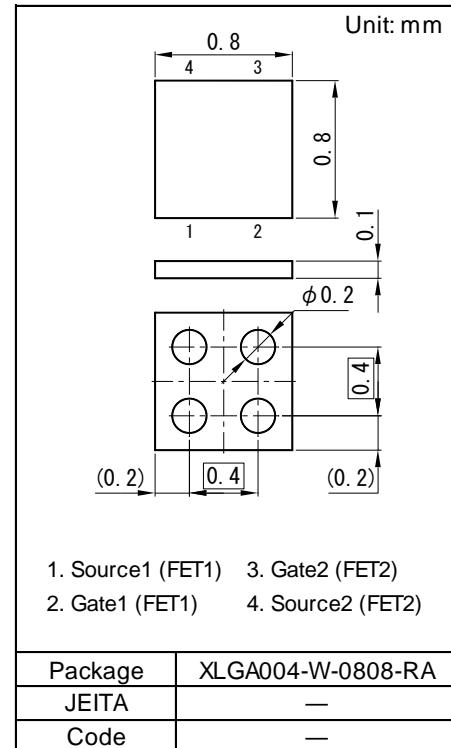
6. THERMAL CHARACTERISTICS $T_a = 25$ °C

Parameter	Symbol	Rating	Unit
Thermal Resistance (ch-a)	R _{th1} ^{*1}	368	°C / W
	R _{th2} ^{*2}	139	°C / W

Note ^{*1} Mounted on FR4 board (25.4 mm x 25.4 mm x t1.0 mm),
using the minimum recommended pad size (36µm Copper).

^{*2} Mounted on Ceramic substrate (70 mm x 70 mm x t1.0 mm).

^{*3} t = 10 µs, Duty Cycle ≤ 1 %



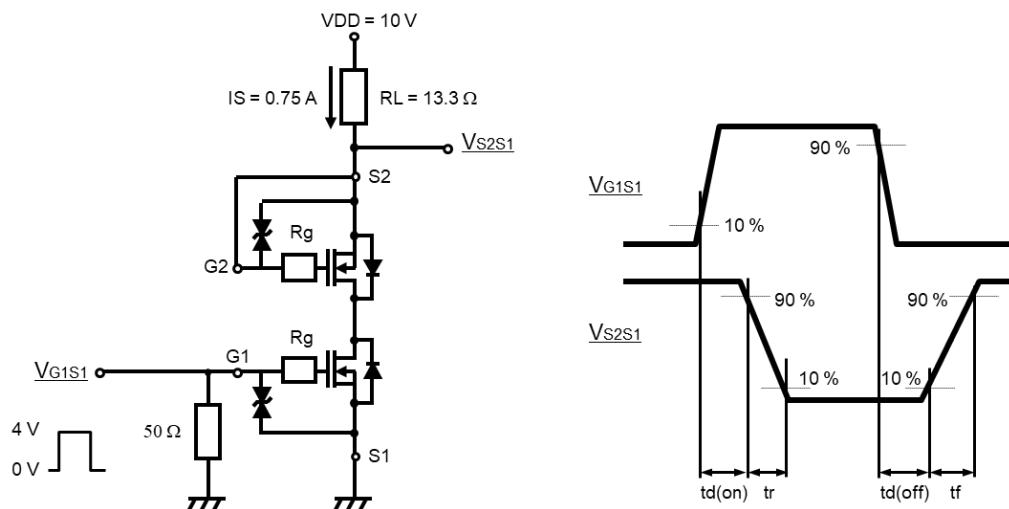
7. ELECTRICAL CHARACTERISTICS $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Source-source Breakdown Voltage	VSSS	$IS = 1 \text{ mA}, VGS = 0 \text{ V}$	12			V
Zero Gate Voltage Source Current	ISSS	$VSS = 12 \text{ V}, VGS = 0 \text{ V}$			1.0	μA
Gate-Source Leakage Current	IGSS	$VGS = \pm 8 \text{ V}, VSS = 0 \text{ V}$			± 10	μA
		$VGS = \pm 5 \text{ V}, VSS = 0 \text{ V}$			± 1.0	
Gate-source Threshold Voltage	V _{th}	$IS = 0.02 \text{ mA}, VSS = 10 \text{ V}$	0.35	0.90	1.40	V
Source-source On-state Resistance	RSS(on)1	$IS = 0.75 \text{ A}, VGS = 4.5 \text{ V}$	70	95	125	$\text{m}\Omega$
	RSS(on)2	$IS = 0.75 \text{ A}, VGS = 3.8 \text{ V}$	75	100	135	
	RSS(on)3	$IS = 0.75 \text{ A}, VGS = 3.1 \text{ V}$	80	115	190	
	RSS(on)4	$IS = 0.75 \text{ A}, VGS = 2.5 \text{ V}$	85	145	285	
Body Diode Forward Voltage	V _{F(s-s)}	$IF = 0.75 \text{ A}, VGS = 0 \text{ V}$		0.6	1.2	V
Input Capacitance ^{*1}	C _{iss}	$VSS = 10 \text{ V}, VGS = 0 \text{ V}, f = 1 \text{ kHz}$		225		pF
Output Capacitance ^{*1}	C _{oss}			45		
Reverse Transfer Capacitance ^{*1}	C _{rss}			35		
Turn-on delay Time ^{*1,*2}	t _{d(on)}	$VDD = 10 \text{ V}, VGS = 0 \text{ to } 4 \text{ V}$ $IS = 0.75 \text{ A}$		0.10		μs
Rise Time ^{*1,*2}	t _r			0.15		
Turn-off delay Time ^{*1,*2}	t _{d(off)}	$VDD = 10 \text{ V}, VGS = 4 \text{ to } 0 \text{ V}$ $IS = 0.75 \text{ A}$		0.40		μs
Fall Time ^{*1,*2}	t _f			0.30		
Total Gate Charge ^{*1}	Q _g	$VDD = 10 \text{ V}$ $VGS = 0 \text{ to } 4 \text{ V}$ $IS = 0.75 \text{ A}$		1.7		nC
Gate-source Charge ^{*1}	Q _{gs}			0.5		
Gate-drain Charge ^{*1}	Q _{gd}			0.45		

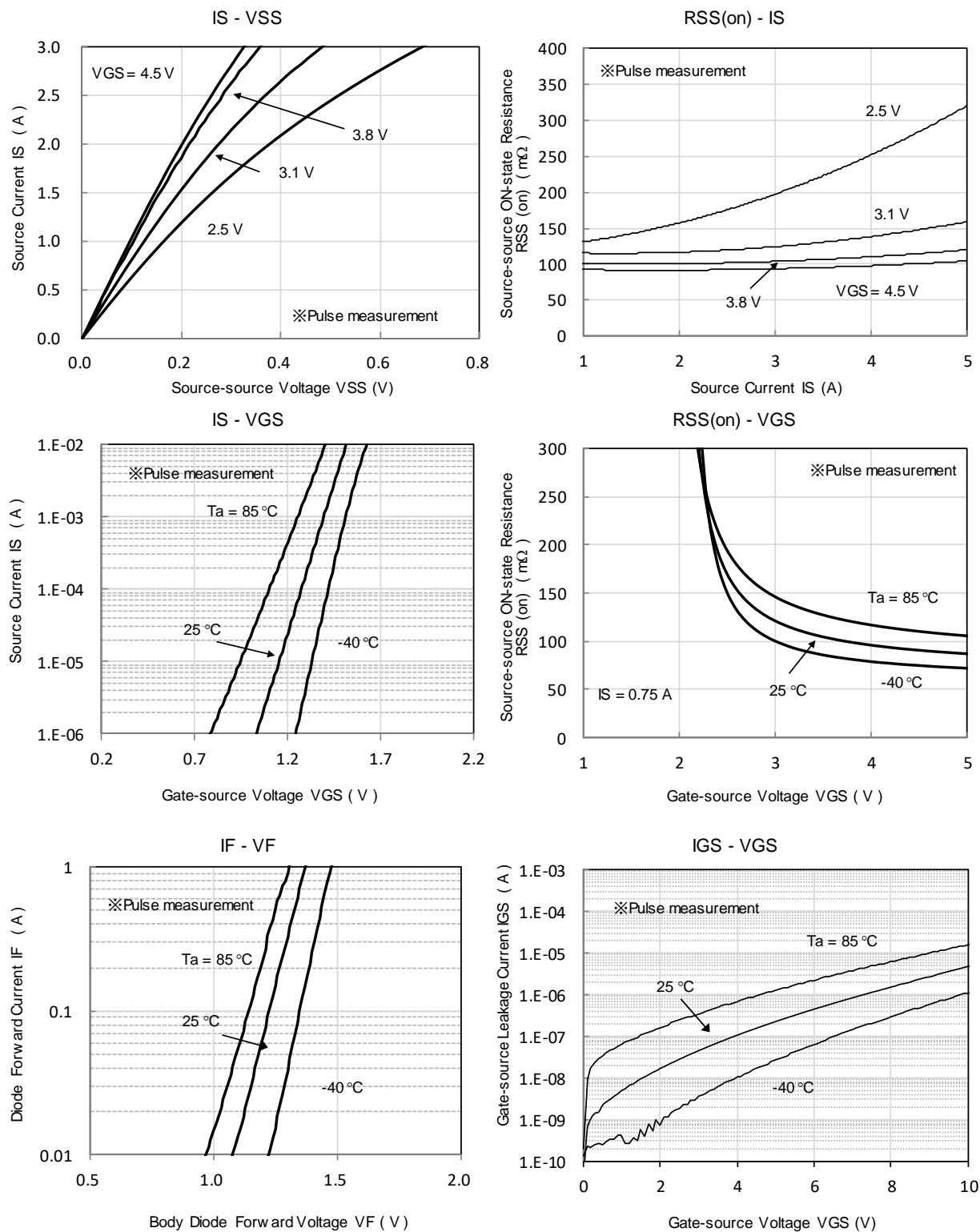
Note Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 Measuring methods for transistors.

*1 Guaranteed by design, not subject to production testing

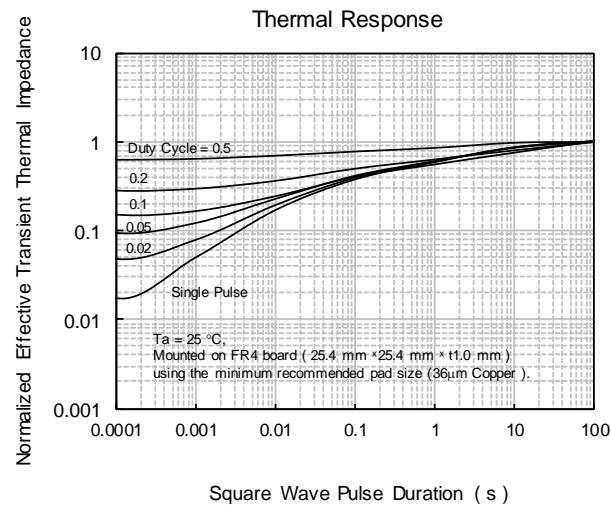
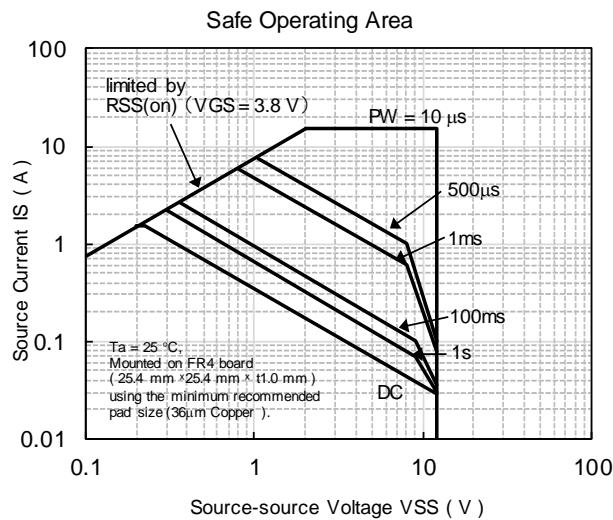
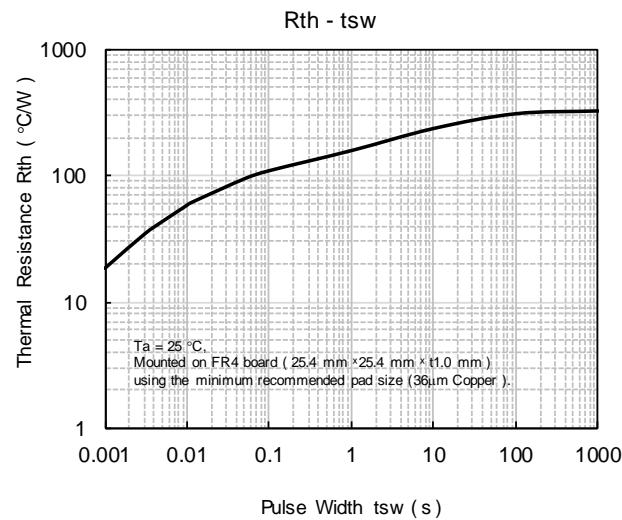
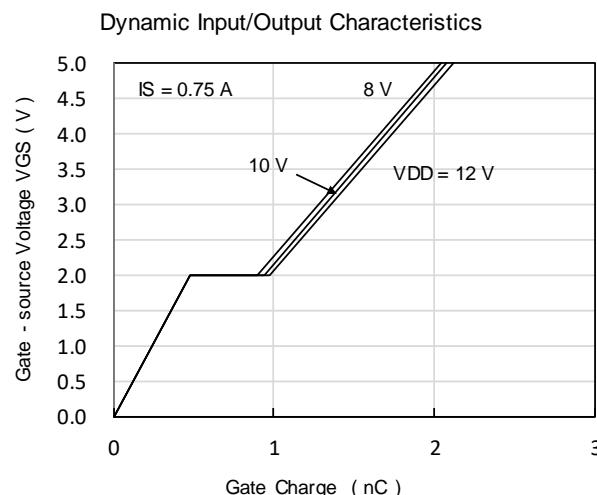
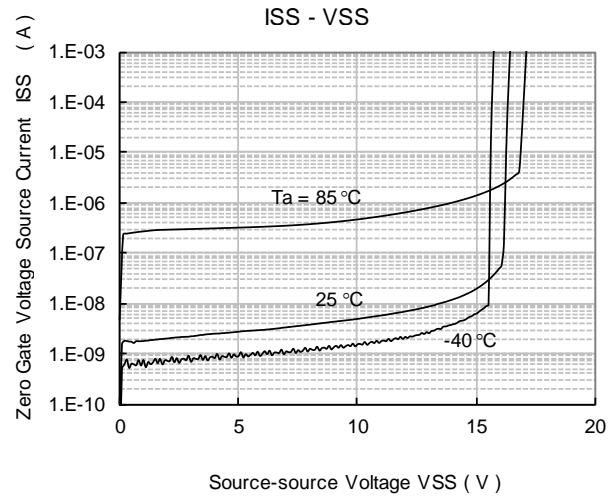
*2 Measurement circuit for Turn-on Delay Time / Rise Time / Turn-off Delay Time / Fall Time



8. TECHNICAL DATA (Reference)

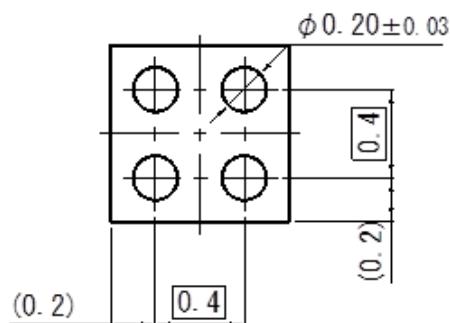
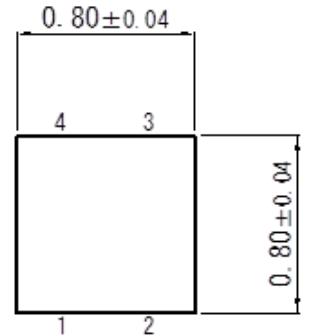


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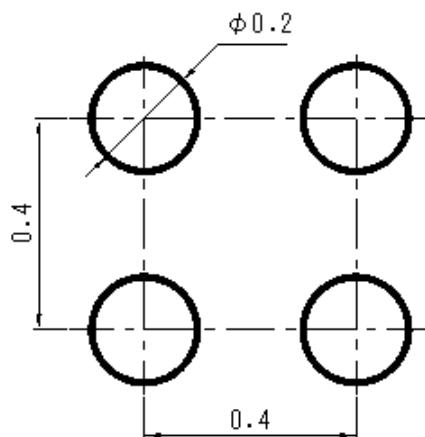


9. OUTLINE

Unit : mm

**10. LAND PATTERN (Reference)**

Unit : mm



11. REVISION HISTORY

Date	Revision	Description
2021.2.5	1.00	1. initially issued.

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